

SINGLE PHASE GLASS PASSIVATED BRIDGE RECTIFIER

GBU4A THRU GBU4M

VOLTAGE RANGE CURRENT 50 to 1000 Volts 4.0 Ampere

FEATURES

- · UL recognized
- High forward surge current capability
- Glass passivated chip junction
- High case dielectric strength
- High temperature soldering guaranteed: 260°C / 10 seconds

MECHANICAL DATA

• Case: Transfer molded plastic

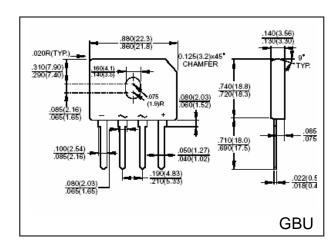
• Terminal: Lead solderable per MIL-STD-750

method 2026

• Polarity: Polarity symbols marked on case

• Mounting: Thru hole for #6 screw, 5-in-lbs Torque max., (Note 3)

• Weight: 0.15 ounce, 4.0 gram



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

- Ratings at 25°C ambient temperature unless otherwise specified
- Single Phase, half wave, 60Hz, resistive or inductive load
- For capacitive load derate current by 20%

	SYMBOLS	GBU4A	GBU4B	GBU4D	GBU4G	GBU4J	GBU4K	GBU4M	UNIT
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward $@T_C = 100^{\circ}C \text{ (Note 1)}$ Rectified Current, $@T_A = 40^{\circ}C \text{ (Note 2)}$	I _(AV)	4.0 3.0							Amps
Peak Forward Surge Current 8.3mS single half sine wave superimposed on rated load (JEDEC method)	I _{FSM}	150							Amps
Rating for Fusing (t<8.3mS)	I ² t	93							A^2s
Maximum Instantaneous Forward Voltage drop per Bridge element 4.0A	V_{F}	1.0							Volts
Maximum DC Reverse Current at Rated $T_A = 25$ °C	I _R 5.0							μA	
DC Blocking Voltage per element $T_A = 125$ $^{\circ}$ C	1 _R	0.5							mA
Typical Junction Capacitance (Measured at 1.0MHz and applied reverse voltage of 4.0V)	C_{J}	100				45		pF	
Typical Thermal Resistance (Note 2)	$R_{\theta Ja}$	22						^o C/W	
Typical Thermal Resistance (Note 3)	$R_{\theta Jc}$	2.5							OC/W
Operating Junction Temperature Range	$T_{\rm J}$	(-55 to +150)						^o C	
Storage Temperature Range	T_{STG}	(-55 to +150)							^o C

Notes:

- 1. Unit mounted on 1.6" x 1.6" x 0.06" (4cm x 4cm x 0.15cm) AL plate
- 2. Unit mounted on PCB with 0.5" x 0.5" (12mm x 12mm) copper pads and 0.375 (9.5mm) lead length
- 3. Recommended mounting position is to bolt down on heatsink using #6 screw and silicon thermal compound for maximum heat transfer



RATINGS AND CHARACTERISTIC CURVES GBU4A THRU GBU4M

